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Katagiri

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(54) **METHOD FOR MANUFACTURING CONDUCTIVE MEMBER, CONDUCTIVE MEMBER, AND TOUCH PANEL USING SAME**

2201/09881; C23C 18/08; G02F 2001/133541; G02F 1/13439; G02F 1/133528; G02F 1/133504; G02F 1/13338; H01L 51/5268; H01L 51/5206; G06F 2203/04103; G06F 3/045; G06F 3/041; G02B 5/0268; G02B 5/0242

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See application file for complete search history.

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(*) Notice: Subject to any disclaimer, the term of this patent is extended or adjusted under 35 U.S.C. 154(b) by 16 days.

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(30) **Foreign Application Priority Data**

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(Continued)

(57) **ABSTRACT**

A method for manufacturing of a conductive member include forming one of a conductive layer including metal nanowires or a light-scattering layer including insulating light-scattering fine particles on a substrate in a pattern shape; and forming the other of the conductive layer including metal nanowires or the light-scattering layer including insulating light-scattering fine particles on a space of the substrate wherein the one of the conductive layer or the light-scattering layer is not formed.

(52) **U.S. Cl.**
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(Continued)

22 Claims, 10 Drawing Sheets

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